

High-Performance Infrared Photodetectors Driven by Interlayer Exciton in a Van Der Waals Epitaxy Grown HfS₂/MoS₂ Vertical Heterojunction

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The van der Waals (vdW) heterojunctions of transition metal dichalcogenides (TMDCs) provide an advanced platform for interlayer exciton generation to detect the exceeding cutoff wavelengths of individual TMDCs. Herein, the first demonstration of high-performance infrared (IR) photodetectors driven by interlayer excitons and based on HfS₂/MoS₂ vdW heterojunctions grown by chemical vapor deposition is presented. HfS₂ exhibits selective growth only on MoS₂, establishing a vertical heterojunction that effectively generates interlayer excitons. The synthesized HfS₂/MoS₂ vertical heterojunction with type-II band alignment exhibits a low interlayer bandgap and a significantly large interface area, enabling highly efficient IR detection. Moreover, the built-in potential in HfS₂/MoS₂ plays a pivotal role in the outstanding photoresponse by suppressing the dark current and providing gradient band bending for the interlayer exciton-induced photocarriers to drift toward each electrode. The HfS₂/MoS₂ photodetector exhibits remarkable performance, achieving a detectivity (D^*) of $\approx 7 \times 10^{13}$ Jones at 1550 nm, D^* of $\approx 2 \times 10^{14}$ Jones at 980 nm, and fast response time of 60 μ s, surpassing previously reported 2D photodetectors. Overall, the successful demonstration of a photodetector based on vdW epitaxial HfS₂/MoS₂ paves the way for the advancement of large-scale high-performance IR sensors.

studies, engineering production, geological prospecting, medical examinations, night-time imaging, chemically specific remote sensing, and photon counters in photonic quantum computers.^[1–4] The demand for high-performance IR sensors is on the rise, as required by advancements in application devices. However, in the near future, the commercialization of photodetectors based on InGaAs and Si will encounter significant challenges, such as lattice mismatch between the semiconductor material and the mother substrate.^[5–7]

2D semiconductors exhibit exotic properties such as the absence of dangling bonds and the ability to form van der Waals (vdW) bonds with other materials, offering a distinct advantage over conventional semiconductors.^[8–10] These remarkable benefits have led to many reports on high-performance photodetectors based on vdW heterojunctions of 2D semiconductors with clean interfaces induced by vdW gaps.^[10,11] However, most photodetectors based on vdW heterojunctions focus on detecting visible light.^[12,13]

Although there have been several reports on IR detection in recent years, a significant challenge remains owing to the issue of high dark currents in such devices.^[10,12,14] The trade-off between low dark current and the detection of long wavelengths, imposed

1. Introduction

Infrared (IR) photodetectors are important for a wide range of civilian and military applications, including modern scientific

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by the small bandgap necessary for IR detection, is a major hurdle for achieving low-noise photodetectors.^[15]

Recently, a novel approach was introduced in the form of IR detectors that operate by interlayer excitons within a vdW heterojunction to overcome the aforementioned issue.^[16–19] vdW heterojunctions with a type-II band alignment formed by transition metal dichalcogenides (TMDCs) offer an advanced platform for generating interlayer excitons, enabling the detection of wavelengths that exceed the cutoff limits of individual TMDCs.^[10,17,19] Interlayer excitons in vdW heterojunctions arise from the Coulomb interaction between electrons and localized holes.^[20,21] The spatial segregation of excitons across two distinct layers leads to advantageous characteristics, including broadening of the photoresponse wavelength, enhancement in exciton lifetime, and generation of an oriented nonzero electric dipole moment with mutually repulsive interactions.^[16] These unique characteristics of interlayer excitons present new avenues for designing high-performance optoelectronic devices that eliminate the trade-off between low dark currents and the detection of long wavelengths.^[10,16] A few reports have presented promising IR photodetectors powered by interlayer excitons.^[10,17,22,23] However, the devices based on mechanically exfoliated flakes are limited to unit devices.^[10,17,22,23]

Herein, we present the first demonstration of high-performance IR photodetectors that operate by interlayer excitons and are fabricated based on vdW heterojunctions grown by chemical vapor deposition (CVD), marking a significant milestone in the field of optoelectronic devices. We selected a heterojunction platform utilizing a combination of HfS₂ and MoS₂ as the interlayer exciton-driven IR detector. This was motivated by the selective growth of HfS₂ and the appropriate band offsets of HfS₂ and MoS₂.^[24–26] In our two-step CVD process, HfS₂ exhibited selective growth only on MoS₂, allowing for the establishment of a vertical heterojunction with a substantial interface area and providing favorable conditions for the generation of interlayer excitons. In addition, the conduction band edge of HfS₂ is located at 5.2 eV which is a large value compared with other TMDs.^[27,28] Therefore, the difference between the conduction band edge of HfS₂ and the valence band edge of MoS₂ is small, enabling the formation of an interlayer bandgap that is sufficiently narrow for IR detection.^[26,28]

Furthermore, the significant contribution of the built-in potential within the HfS₂/MoS₂ heterojunction was instrumental in achieving exceptional photoresponse in the HfS₂/MoS₂ photodetector. This built-in potential effectively suppresses the dark current and facilitates gradient band bending, enabling an efficient drift of the interlayer exciton-induced photocarriers toward the respective electrodes. Our HfS₂/MoS₂ photodetector exhibits remarkable performance, achieving a photoresponsivity (*R*) of $\approx 600 \text{ A W}^{-1}$, detectivity (*D*^{*}) of $\approx 7 \times 10^{13}$ Jones at 1550 nm, and *R* of $\approx 1500 \text{ A W}^{-1}$ and *D*^{*} of $\approx 2 \times 10^{14}$ Jones at 980 nm. Additionally, the photodetector exhibited fast rise and decay times of 60 and 71 μs , respectively.

2. Results and Discussion

Figure 1a illustrates the procedure for synthesizing a vdW vertical heterojunction of HfS₂ and MoS₂ using a two-step method. We previously reported a synthetic method for obtaining large-grain

MoS₂ through CVD assisted by an alkali metal halide (AMH).^[29] Briefly, in the first step, a mixture of an AMH (NaCl) and a metal source (MoO₃) is deposited onto a SiO₂/*p*-Si substrate through thermal evaporation. This mixture served as a reactant for the formation of large-grained MoS₂.^[29] Subsequently, the deposited mixture is placed inside a quartz tube and reacts with sulfur at a temperature of 750 °C. The synthesized MoS₂ flakes, which act as the platform for HfS₂ synthesis, exhibit a flake size of $\approx 200 \mu\text{m}$ with a coverage of 86% (Figure 1a inset). The synthesized MoS₂ with significant grain sizes can offer ample space as a platform for the creation of numerous nucleation sites. Additionally, it facilitates effective adsorption and diffusion of Hf and S sources on the MoS₂ surface, allowing the synthesis of HfS₂ at these nucleation sites.^[30,31] The second step involved a catalyst-assisted CVD method for growing vdW epitaxy-based HfS₂ on MoS₂. NaCl and HfCl₄ powders were used at a fixed mass ratio of 1:3 (NaCl:HfCl₄). The sources reacted under an Ar and H₂ atmosphere at 760 Torr/950 °C on the synthesized MoS₂.

Figure 1b and Figure S1 (Supporting Information) present the scanning electron microscopy (SEM) and the optical image of the synthesized HfS₂/MoS₂ heterojunctions. In the SEM image, hexagonal HfS₂ is clearly observed on the surface of the MoS₂. The average grain size of the HfS₂ is 6.75 μm , as shown in Figure 1c. Although the size of each individual HfS₂ is only a few micrometers, they merge with one another, resulting in the formation of numerous large-area regions, leading to an HfS₂ coverage of $\approx 79\%$ on the MoS₂ substrate. In addition, a small amount of bulk HfS₂ is synthesized along the grain boundaries of MoS₂, where the surface energy is relatively high.^[32] Moreover, to demonstrate the uniform synthesis of HfS₂ across various locations on the MoS₂ substrate, we present four SEM images of HfS₂/MoS₂ taken at different positions (Figure S2a–d, Supporting Information). In all four SEM images, the presence of hexagonally structured HfS₂ is evident. Although there may be slight variations in HfS₂ coverage, it is observable that a predominant layer of a few HfS₂ layers has been consistently synthesized on all MoS₂ surfaces. The thickness profile of HfS₂ in the inset of Figure 1b reveals that the HfS₂ flakes formed on the MoS₂ substrate had a thickness of 3.5 nm, corresponding to five layers of HfS₂. The SEM image clearly shows that HfS₂ exhibits a preference for specific substrates. Notably, HfS₂ hardly grew on the SiO₂ region but only on the MoS₂ substrate. This intriguing selectivity can be attributed to the disparity in the surface energy associated with the surface diffusion of reactants, which is influenced by the morphological characteristics of the respective mother substrates.^[31]

The growth of HfS₂ by CVD involves two primary steps: First, the vaporized reactants are deposited onto the mother substrate, and second, the adsorbed species undergo diffusion on the mother substrate.^[31] During the synthesis of HfS₂ at high temperatures, the migration rate of the reactant molecules was higher on the MoS₂ substrate than on the SiO₂ substrate.^[31] This was attributed to the absence of dangling bonds in MoS₂, which facilitated faster migration.^[31] The enhanced migration rate provided sufficient time for the adsorbed HfS₂ molecules to achieve a minimum energy state, promoting the growth of HfS₂ on the MoS₂ substrate by lowering the cohesive energy.^[31] To quantitatively compare the cohesive energy of HfS₂/MoS₂ and HfS₂/SiO₂, we employed density functional theory (DFT)

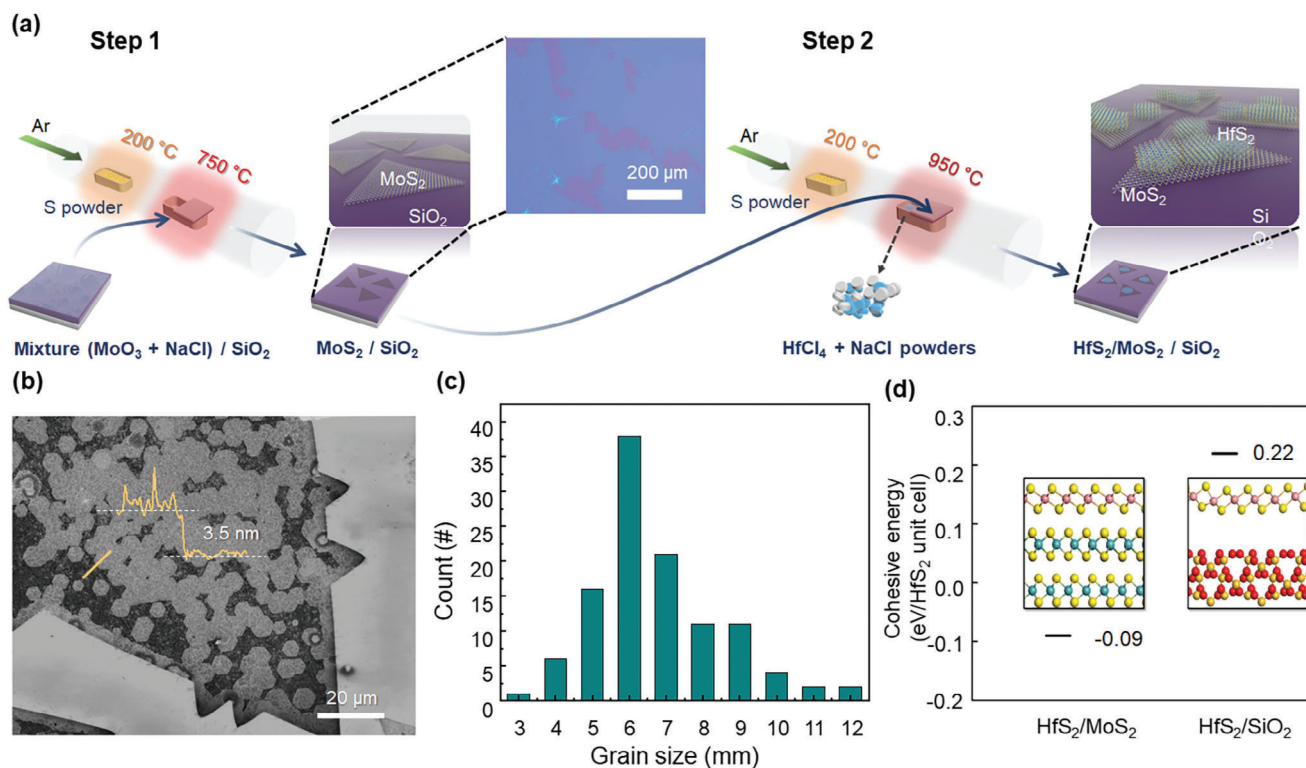


Figure 1. a) Schematic of overall two-step HfS₂/MoS₂ synthesis procedures. The Inset image is a synthesized MoS₂ and the scaler bar denotes 200 μm. b) SEM image and (inset) thickness profile of synthesized HfS₂/MoS₂ and the scaler bar denotes 20 μm. c) Distribution of HfS₂ hexagons grain size from SEM. d) Calculated cohesive energy per HfS₂ unit cell of HfS₂/MoS₂ and HfS₂/SiO₂.

calculations to theoretically calculate the cohesive energy. The theoretical models are shown in Figure 1d. The value of cohesive energy is calculated using the formula $E_{\text{cohesive}} = (E_{\text{HfS}_2/\text{sub}} - E_{\text{HfS}_2} - E_{\text{sub}})/n$, where $E_{\text{HfS}_2/\text{sub}}$, E_{HfS_2} , E_{sub} , and n represent the total energy of HfS₂/MoS₂ or HfS₂/SiO₂, HfS₂, MoS₂, or SiO₂, the number of HfS₂ units in the HfS₂/MoS₂ or HfS₂/SiO₂.^[31] The results of the DFT calculations reveal that the cohesive energies of HfS₂/MoS₂ and HfS₂/SiO₂ structures are -0.09 and 0.22 eV, respectively, as shown in Figure 1d. The cohesive energy of HfS₂/SiO₂ is over zero, and a significant cohesive energy difference of 0.31 eV is observed between HfS₂/SiO₂ and HfS₂/MoS₂. This energy difference clearly explains the selective growth of HfS₂ on the MoS₂ substrate. Despite the growth of HfS₂ exhibiting selectivity, when the substrate is exposed to excessive metal sources, bulk HfS₂ with a grain size of less than 1 μm can be observed on SiO₂, as shown in Figure S3 (Supporting Information). This is because the high temperature required for synthesizing HfS₂ allows some of the remaining reactants not to participate in the formation of HfS₂/MoS₂ to overcome the cohesive energy of HfS₂/SiO₂.^[31] Furthermore, under the same conditions, the coverage of few-layer HfS₂ and bulk HfS₂ on the MoS₂ substrate also increased (Figure S3, Supporting Information) due to the excessive metal sources. In our two-step CVD process, HfS₂ grew selectively exclusively on MoS₂, leading to the formation of a vertical heterojunction with a significant interface area, which was beneficial for generating interlayer excitons.

Raman spectroscopy and photoluminescence (PL) were employed to investigate the structural and optical properties of pris-

tine MoS₂ and HfS₂/MoS₂, as shown in Figure 2a–c. In the Raman spectrum of pristine MoS₂ (Figure 2a), two characteristic Raman peaks are observed at 384.2 and 403.4 cm⁻¹, corresponding to the E_{2g}¹ and A_{1g}¹ vibrational modes, respectively.^[26,33] The E_{2g}¹ peak exhibits a small full width at half maximum of 3.9 cm⁻¹, and there is a peak-to-peak distance of 19.2 cm⁻¹ between E_{2g}¹ and A_{1g}¹. These observations indicate that the synthesized monolayer MoS₂ exhibits a quality comparable to that of the flakes exfoliated from bulk single crystals.^[26,33] After HfS₂ synthesis, a noticeable blue shift is observed in the A_{1g} mode while the position of the E_{2g}¹ vibration mode exhibits a relatively small difference (Figure S4, Supporting Information). This shift suggests that MoS₂ is *p*-doped because of the junction with HfS₂, which has a higher Fermi level than MoS₂.^[33] Additionally, the out-of-plane mode A_{1g} peak exhibited a more pronounced shift than the in-plane mode E_{2g}¹ peak, which can be attributed to the growth of HfS₂ on the MoS₂ surface.^[33] Furthermore, comparing MoS₂ in the region where HfS₂ was not synthesized and the pristine MoS₂ subsequent to HfS₂ synthesis, one can observe nearly no shift in the vibration mode. This indicates that there are no additional defects generated in MoS₂, and Hf doping doesn't take place during the high-temperature growth of HfS₂.^[34] Therefore, the high-quality state of MoS₂ is preserved evidently (Figure S5, Supporting Information). The Raman spectra of the HfS₂/MoS₂ heterostructure also exhibit a distinct vibrational mode of HfS₂ at 335 cm⁻¹.^[24,25] In the case of few-layer HfS₂/MoS₂, the intensity of the HfS₂ Raman signal is significantly lower compared to

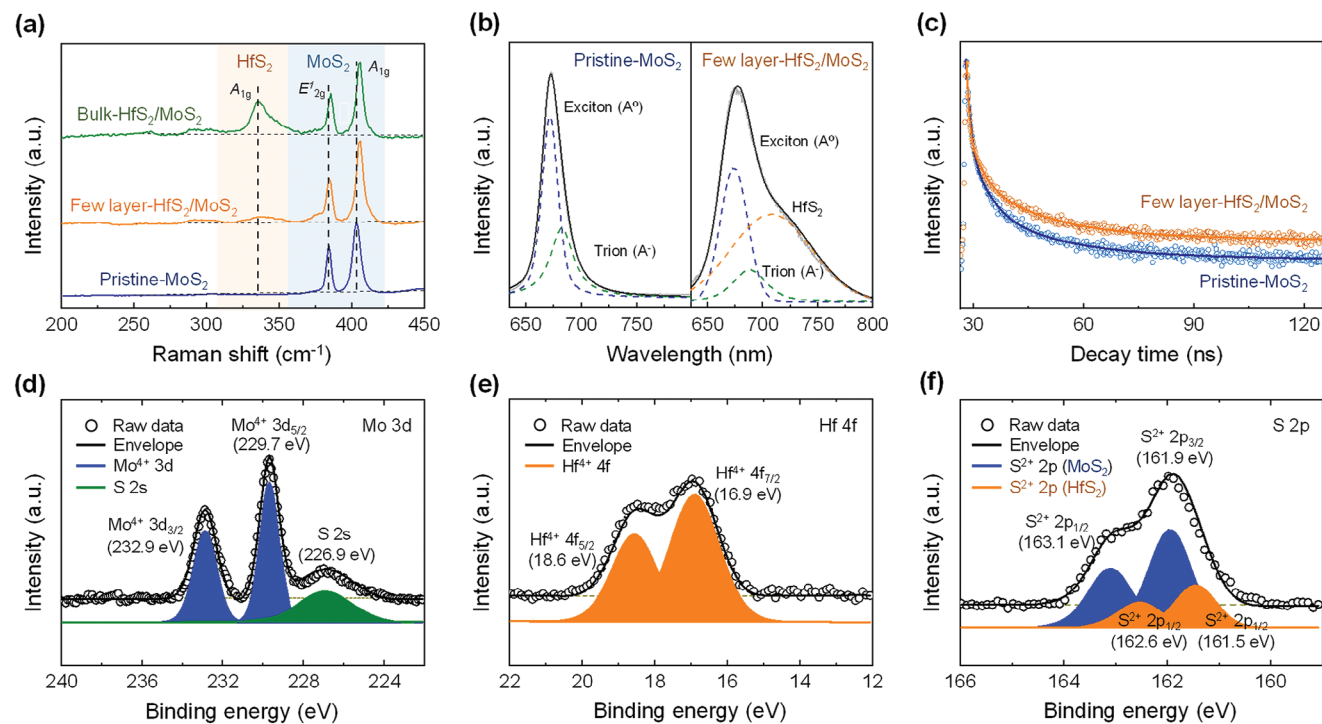


Figure 2. a) Raman spectra of bulk HfS₂/MoS₂, few layer HfS₂/MoS₂, and pristine MoS₂. b) PL spectra of few layer HfS₂/MoS₂ and pristine MoS₂. c) TRPL spectra of HfS₂/MoS₂ and MoS₂, d) Mo 3d and S 2s, e) Hf 4f, and f) S 2p XPS spectra of HfS₂/MoS₂.

bulk HfS₂/MoS₂, which can be attributed to the reduction in the number of scattering centers within the HfS₂ structure.^[24,25] Furthermore, to validate the consistent quality of HfS₂, we conducted Raman spectroscopy at positions corresponding to Figure 1a and Figure S2a–e (Supporting Information). In the Raman spectra, we observed the low-intensity A_{1g} mode of HfS₂ across all the few HfS₂ layers synthesized, irrespective of their position on the MoS₂ substrate (as shown in Figure 2a). This demonstrates a uniform quality of HfS₂ layers synthesized on MoS₂. This implies that the HfS₂/MoS₂ heterojunction, synthesized through our two-step CVD process, has achieved a consistent quality sufficient for potential future device array production.

A comparison of the PL spectra of pristine MoS₂ and few-layer HfS₂/MoS₂ is shown in Figure 2b. The PL spectrum of pristine MoS₂ exhibited a prominent peak at 680 nm, corresponding to the exciton (A⁰, blue) and trion (A⁻, green) emissions.^[33] In contrast, the PL spectrum of the HfS₂/MoS₂ heterostructure revealed the presence of an additional subcurve (orange) with a peak at 715 nm. The observed HfS₂ PL peak position is in line with the previous study.^[35] However, many publications indicate peak positions that vary from this specific peak.^[24,25,36] The peak position does not match numerous publications that indicate distinct peak positions. This variance is attributed to defects arising during the synthesis of HfS₂.^[35] This peak position falls within the range reported for CVD-grown few-layered HfS₂.^[24,25,36] The PL curve of HfS₂/MoS₂ displays a decrease of the intensity ratio of A⁻/A⁰ from 0.38 (MoS₂) to 0.24 (HfS₂/MoS₂) compared to that of pristine MoS₂.^[33,37] This phenomenon can be attributed to *p*-doping, wherein electrons are transferred from MoS₂ to HfS₂, as agreed with the Raman analysis.^[33,37] Moreover, the PL peak in-

tensity of HfS₂/MoS₂ heterostructure is significantly lower than that of pristine MoS₂ (Figure S6, Supporting Information), which was attributed to the reduced recombination of the photogenerated carriers through HfS₂/MoS₂ heterojunction.^[38,39] To further analyze the optical properties, time-resolved PL measurements were performed, as shown in Figure 2c. The PL decay curves were measured at the peak positions in the PL spectra. The average lifetime extracted from Figure 2c is prolonged in HfS₂/MoS₂ compared to that in pristine MoS₂. This suggests that the HfS₂/MoS₂ heterojunction reduces nonradiative recombination in MoS₂ and has more compatibility for enhanced efficiency of separating photoinduced electron–hole pairs, which is consistent with the PL results.^[38–41]

Based on the aforementioned Raman and PL spectroscopy results, we conclude that the HfS₂/MoS₂ heterojunction was synthesized via a two-step CVD process. To further elucidate the chemical composition of the heterostructure, chemical identification of HfS₂/MoS₂ was implemented by X-ray photoelectron spectroscopy (XPS) measurements (Figure 2d–f; Figure S7, Supporting Information). The XPS profiles of the Mo 3d, Hf 4f, S 2s, and S 2p core levels of the HfS₂/MoS₂ heterojunction are shown in Figure 2d–f. In Figure 2d, the deconvoluted peak profiles indicate the presence of Mo 3d_{5/2} and Mo 3d_{3/2} orbitals in intrinsic MoS₂, as well as S 2s orbitals in MoS₂.^[24,25,29,33] These profiles demonstrate the absence of Mo 3d and MoS_x orbitals in the defective MoS₂ and MoO_x.^[42] Furthermore, no signals corresponding to the Na and Cl orbitals, which are contaminants from the catalyst used in the synthesis process, were observed (Figure S8, Supporting Information). These results suggest that pristine MoS₂ synthesized using the AMH-assisted CVD method

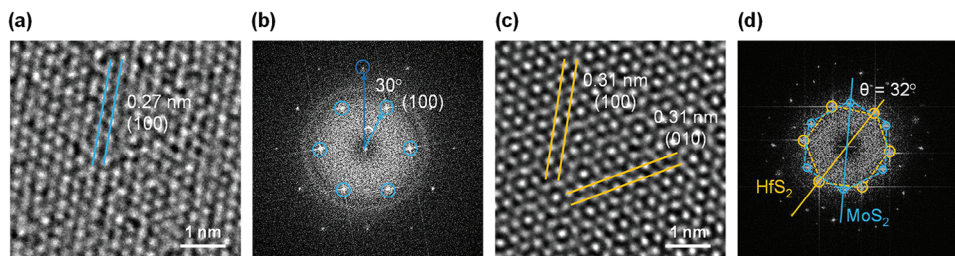


Figure 3. a,b) Top view HRTEM image and corresponding FFT analysis of MoS₂. c,d) HRTEM image of HfS₂/MoS₂ heterojunction with moiré patterns and corresponding FFT analysis. The scaler bar denotes 1 nm.

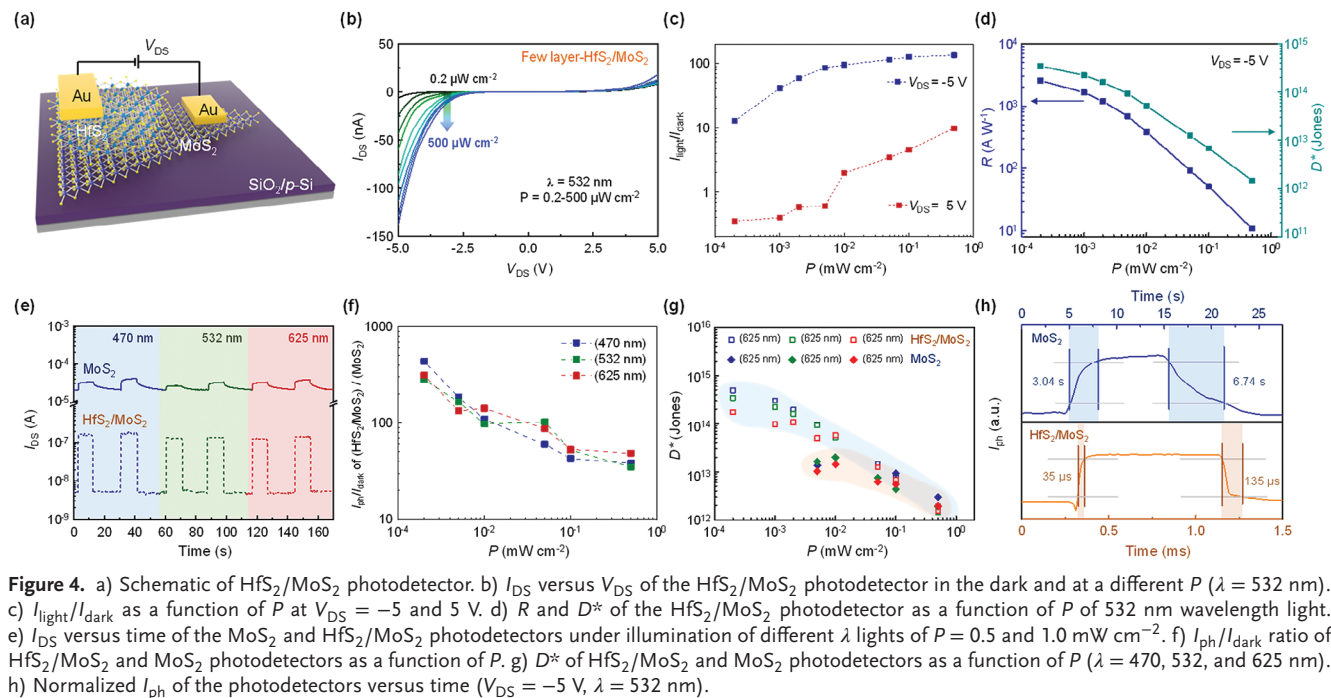
is of high quality and devoid of structural defects and undesirable impurities. In Figure 2e, distinct peaks corresponding to the Hf 4f_{5/2} and Hf 4f_{7/2} orbitals are observed at 18.6 and 16.9 eV, respectively, indicating the presence of HfS₂ without any detectable HfO_x orbitals.^[24,25] The XPS spectra in the range of 160–165 eV for S 2p orbitals exhibit deconvoluted peak profiles at 162.6 and 161.5 eV for HfS₂, and 163.1 and 161.9 eV for MoS₂, as shown in Figure 2f.^[24,25] By comparing the areas of the S 2p (MoS₂, blue)/Mo 3d and S 2p (HfS₂, orange)/Hf 4f orbitals, the stoichiometry of MoS₂ and HfS₂ can be determined. The ratios of these areas provided stoichiometries are 1.98:1 (S:Mo) for MoS₂ and 2.01:1 (S:Hf) for HfS₂. Comparing it with the atomic ratio of Mo and S in pristine MoS₂ (S:Mo = 1.97:1), we observe nearly negligible differences (Figure S9, Supporting Information). Therefore, XPS analysis showed the clear orbitals of MoS₂ and HfS₂ and confirmed the presence of high-quality HfS₂/MoS₂ without additive defects in MoS₂ and Hf doping.

To confirm directly the presence of a vertical heterojunction between HfS₂ and MoS₂, high-resolution transmission electron microscopy (HRTEM) images and corresponding fast Fourier transform (FFT) analyses were obtained, as shown in Figure 3. The HRTEM image (Figure 3a) and selected area electron diffraction (SAED) pattern (Figure 3b) show the presence of high-quality 2H-MoS₂ monolayers.^[29] In Figure 3c,d, the HRTEM image reveals a hexagonal structure of Hf atoms, with crystal distances of 0.31 nm corresponding to the (100) and (110) planes.^[24] In the folded region of the HfS₂/MoS₂ heterojunction, five distinguishable layers were observed at the folding boundary, with a layer distance of 0.59 nm, consistent with the previously reported lattice information of HfS₂ (Figure S10, Supporting Information).^[24] The thickness information of HfS₂ obtained from HRTEM complements the thickness profile obtained from atomic force microscopy analysis, further confirming the accurate thickness of HfS₂. Additionally, Figure 3c shows the moiré patterns induced by the overlapping of 2H MoS₂ and 1T HfS₂ at a rotation angle of 32°.^[43] The dominant moiré pattern is characterized by a hexagonal arrangement, with six Hf atoms surrounding a central Hf atom.^[43] Moreover, Figure S11a (Supporting Information) shows a variety of moiré patterns (depicted in orange, red, and blue), and it is clear that these patterns align accurately in both shape and position with those portrayed in the TEM image (Figure S11, Supporting Information). The rotation angle can be observed in the heterojunction of the 1T/2H structure, which also reveals that HfS₂ is freestanding on MoS₂.^[43] Moreover, the rotation angle extracted from the HRTEM image is similar to the stacking angles observed in SEM images (Figure S12, Supporting Information).

The stacking angles of the heterojunctions exhibit low disorientation between 1T HfS₂ and 2H MoS₂, suggesting the minimal presence of MoS₂ wrinkles or contamination at the interface.^[44] These results provide clear evidence of a vertical heterojunction between 1T HfS₂ and 2H MoS₂, confirming the epitaxial growth of HfS₂ on MoS₂. This epitaxial growth without undesirable contamination is favorable for generating a large number of photoinduced carriers at the interface between HfS₂ and MoS₂.

A schematic (optical image) of a photodetector based on HfS₂/MoS₂ is presented in Figure 4a (Figure S13, Supporting Information). To exploit the asymmetric energy band structure of the epitaxially grown HfS₂/MoS₂ vertical heterojunction, we strategically aligned the drain and source electrodes on MoS₂ and HfS₂, respectively. Figure 4b shows the characteristics of drain current (I_{DS}) versus drain voltage (V_{DS}) for the HfS₂/MoS₂ photodetector in the dark and under the illumination of different incident light powers ($P = 0.2$ – $500 \mu\text{W cm}^{-2}$). In the dark, the device exhibited similar electrical properties regardless of the polarity of V_{DS} , indicating no significant difference in the energy barrier between the source and drain, even in the presence of a heterojunction (Figure S14, Supporting Information). However, in the case of the optoelectrical properties, the photocurrent ($I_{ph} = I_{light} - I_{dark}$) and the ratio of I_{light} to I_{dark} (I_{light}/I_{dark}) of the device, where I_{light} and I_{dark} denote I_{DS} under illumination and in the dark, respectively, exhibited noticeable differences at $V_{DS} = -5$ V compared to $V_{DS} = 5$ V, as depicted in Figure 4b,c. The value of I_{ph} increases as the incident P increases, following the relationship $I_{ph} \approx P^\alpha$.^[45] The power factor (α), which represents the efficiency of photodetection, is more than 10 times higher at $V_{DS} = -5$ V compared to at $V_{DS} = 5$ V under visible light illumination (470, 532, and 625 nm), as shown in Figure S15 (Supporting Information).^[45] The asymmetric photodetection efficiency of our photodetector by the polarity of V_{DS} will be comprehensively discussed in the subsequent paragraph with additional details.

The band alignment of the HfS₂/MoS₂ photodetector in V_{DS} direction is shown in Figure S16 (Supporting Information) to explain in more detail about difference of the optoelectrical properties by V_{DS} polarity. The electron affinity values of HfS₂ and MoS₂ were reported as 5.2 and 3.9 eV, respectively, and the bandgaps of HfS₂ and MoS₂ were determined from the PL spectra.^[26,28] As shown in Figure S16 (Supporting Information), when V_{DS} is negative, gradient band bending occurs in the device, allowing photoinduced electrons from both MoS₂ and HfS₂ to readily flow toward the respective electrodes. The presence of this band bending facilitates the significant contribution of



photoelectrons to the overall photocurrent. Conversely, in the positive V_{DS} regime, an energy barrier was formed at the interface between MoS₂ and HfS₂, impeding the transfer of photoinduced electrons from HfS₂ to MoS₂. Furthermore, the main channel for photoelectrons differs depending on the polarity of V_{DS} , with HfS₂ being the main channel at a negative V_{DS} and MoS₂ at a positive V_{DS} . This distinction arises from the different directions of charge transfer associated with the polarity of V_{DS} . Notably, the mobility of HfS₂ was more than four times that of MoS₂.^[46] The high drift velocity of the photoelectrons, determined by the high carrier mobility of the main channel, allows sufficient transit time for the photoelectrons to reach the electrode before recombination occurs owing to scattering effects.^[47]

To compare the photoelectric properties of the HfS₂/MoS₂ photodetectors based on the carrier mobility of the main channel, Figure S17 (Supporting Information) shows the ratio of I_{ph} at $V_{DS} = -5$ V to I_{ph} at $V_{DS} = 5$ V ($I_{ph-5 V} / I_{ph+5 V}$) as a function of P . The ratio of I_{ph} increases with increasing P in the range of 0.2 – 50 $\mu\text{W cm}^{-2}$. This behavior can be attributed to the fact that in MoS₂, which has a low mobility, the scattering between the photoelectrons intensifies as the photocarrier density increases.^[47,48] In contrast, in HfS₂, which has high mobility, scattering does not significantly increase because of the short transit time of the photoelectrons. However, the ratio of I_{ph} decreases in the range of 50 – 500 $\mu\text{W cm}^{-2}$ owing to increased scattering in HfS₂, similar to the behavior observed in MoS₂. Therefore, the high photodetection efficiency at negative V_{DS} can be attributed to the high drift velocity of the photoelectrons in HfS₂, along with the presence of a gradient band. This is why our photodetector exhibited remarkable performance under a negative bias compared to a positive bias. The extracted photoresponsivity (R) and detectivity (D^*) of our photodetector as functions of P are shown in Figure 4d, where $R = I_{ph}/PA$, $D^* = RA^{1/2}/(2qI_{noise})^{1/2}$,

A denotes the active area for photodetection, q denotes the electron charge, and I_{noise} denotes the I_{dark} .^[26,40] We calculated detectivity by taking I_{dark} as I_{noise} . This is a method commonly used in many 2D materials based on photodetectors,^[26,33,49,50] but at low frequencies ($<$ few kHz), it is not white noise but G-R noise resulting from the trapping/de-trapping and generation/recombination processes of carriers within the active layer, and flicker ($1/f$) noise is dominant.^[51–53] Therefore, the noise measured by the methods is underestimated and the detection performance of the device is also overestimated.^[51–53] To obtain a correct value for I_{noise} , excluding flicker noise dominant at lower frequencies, a system to measure NEP is required.^[54,55] However, due to the unavailability of such a system during the research, I_{dark} was utilized. The active area of our photodetector is 2500 μm^2 (width: 50 μm and length: 50 μm). Notably, our HfS₂/MoS₂ photodetector exhibits R values exceeding 2500 A W^{-1} and achieves D^* of $\approx 4 \times 10^{14}$ Jones.

We fabricated the MoS₂ photodetector to compare its optoelectrical properties with those of the HfS₂/MoS₂ photodetector at $V_{DS} = -5$ V. Figure 4e–h shows that the optoelectrical properties of the HfS₂/MoS₂ and MoS₂ photodetectors were measured using excitation in the visible range ($470, 532,$ and 625 nm). It was observed that both I_{dark} and I_{light} of the MoS₂ photodetector were significantly higher than those of the HfS₂/MoS₂ devices. This disparity can be attributed to the absence of a built-in potential in the MoS₂ photodetector, except for the junction at the MoS₂/electrode interface. In contrast, the HfS₂/MoS₂ photodetector exhibits reduced I_{dark} and I_{light} values because of the presence of an energy barrier that restricts the electron flow at the interface between HfS₂ and MoS₂, thereby minimizing the dark current to a few nanoamperes. Interestingly, the HfS₂/MoS₂ photodetector exhibited an unprecedented improvement in I_{ph}/I_{dark} , exceeding that of the MoS₂ photodetector by more than 100 times

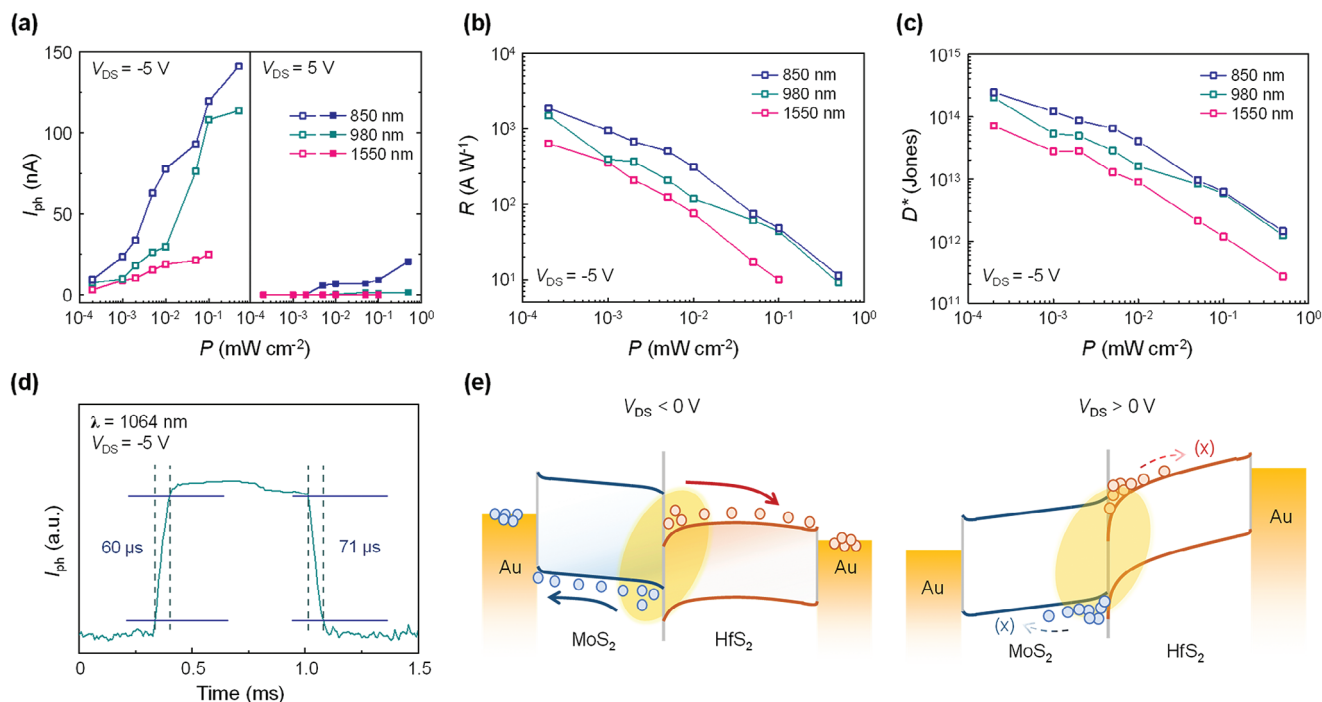


Figure 5. IR sensor based on $\text{HfS}_2/\text{MoS}_2$ driven by interlayer exciton. a) I_{ph} as a function of P at $V_{\text{DS}} = -5$ and 5 V ($\lambda = 850, 980,$ and 1550 nm). b, c) R and D^* as a function of P under the illumination of $850, 980,$ and 1550 nm wavelength light ($V_{\text{DS}} = -5$ V). d) Normalized I_{ph} versus time ($\lambda = 1064$ nm). e) Schematic diagram of band alignment of the $\text{HfS}_2/\text{MoS}_2$ photodetector under $V_{\text{DS}} < 0$ V (left) and $V_{\text{DS}} > 0$ V (right) and the photoinduced carrier extraction process.

(Figure 4f). Moreover, the $\text{HfS}_2/\text{MoS}_2$ photodetector exhibited superior D^* at low P values compared with the MoS_2 photodetector. It achieved a D^* of $\approx 5 \times 10^{14}$ Jones under a low P , which MoS_2 alone cannot detect. These improvements are ascribed not only to the energy barrier of the $\text{HfS}_2/\text{MoS}_2$ interface that screens the injected carriers, inducing a low dark current but also to the junction with HfS_2 , which possesses excellent optoelectronic properties.^[46] The $\text{HfS}_2/\text{MoS}_2$ photodetector also exhibited an excellent response speed, as evidenced by its rapid rise and decay times, as shown in Figure 4h. These times were extracted based on the transitions from 10% to 90% of the maximum current and 90% to 10% of the current, respectively.^[33] The $\text{HfS}_2/\text{MoS}_2$ photodetector achieves significantly shorter rise ($35 \mu\text{s}$) and decay times ($135 \mu\text{s}$) compared to both the MoS_2 and $\text{HfS}_2/\text{MoS}_2$ photodetectors operating with an applied $V_{\text{DS}} = 5$ V, where the main channel is formed by MoS_2 (Figure S18, Supporting Information).

The photoresponses of the $\text{HfS}_2/\text{MoS}_2$ photodetectors were also investigated at different IR wavelengths ($850, 980,$ and 1550 nm). Figure 5a shows I_{ph} under illumination of IR light as a function of P at $V_{\text{DS}} = -5$ and 5 V. Under 850 nm wavelength light, the $\text{HfS}_2/\text{MoS}_2$ photodetector exhibits a remarkably high photocurrent at $V_{\text{DS}} = -5$ V than that at $V_{\text{DS}} = 5$ V, similar to the behavior observed in the visible light region. However, the $\text{HfS}_2/\text{MoS}_2$ photodetector exhibited no photoresponse at the wavelengths of 980 and 1550 nm at $V_{\text{DS}} = 5$ V. These behaviors of our photodetector suggest that the mechanism for generating photoinduced carriers differs depending on the wavelength. Figure 5b,c shows the R and D^* values of our photode-

tor versus P under illumination at $850, 980,$ and 1550 nm. The $\text{HfS}_2/\text{MoS}_2$ IR sensors exhibited outstanding performance at $V_{\text{DS}} = -5$ V, achieving an R value of $\approx 1500 \text{ A W}^{-1}$ and D^* value of 2×10^{14} Jones at 980 nm, and R of $\approx 600 \text{ A W}^{-1}$ and D^* of 7×10^{13} Jones at 1550 nm. Furthermore, the photoresponse time of the $\text{HfS}_2/\text{MoS}_2$ photodetector was evaluated under the illumination of a 1064 nm laser, as shown in Figure 5d. The rise and decay times were 60 and $71 \mu\text{s}$, respectively, which are comparable to the photoresponse times observed under the illumination of a 532 nm laser. The performance characteristics of our $\text{HfS}_2/\text{MoS}_2$ photodetector surpass those of other previously reported CVD-grown 2D-based IR sensors (Tables S1 and S2, Supporting Information). The detectivity of our $\text{HfS}_2/\text{MoS}_2$ photodetector is several orders higher compared to the reported 2D materials based on photodetector, but considering the issue of overstimulation mentioned above, it is difficult to directly compare the values. Nonetheless, upon comprehensive consideration of other performance metrics such as responsivity and response time, it becomes evident that our $\text{HfS}_2/\text{MoS}_2$ photodetector has reached a remarkable performance.

The generation of photoinduced carriers in the IR range involves two mechanisms: 1) electron-hole pair generation in HfS_2 and 2) interlayer exciton formation at the interface between HfS_2 and MoS_2 . This is supported by the fact that the MoS_2 photodetector, which has a larger bandgap, could not detect IR signals (Figure S19, Supporting Information).^[22] Figure 5e illustrates the process of photoinduced electron extraction by interlayer excitons in the band alignment of $\text{HfS}_2/\text{MoS}_2$ at $V_{\text{DS}} = -5$ and 5 V. At the interface of $\text{HfS}_2/\text{MoS}_2$, the generation of interlayer

excitons under IR light illumination is possible because of the interlayer bandgap of 0.5 eV between the conduction band of HfS₂ and the valence band of MoS₂ (Figure S16, Supporting Information). In the negative V_{DS} region, the photoinduced electrons and holes from the interlayer excitons flow along HfS₂ and MoS₂, respectively, and can easily reach the respective electrodes owing to the applied electric field. In contrast, in the positive V_{DS} region, the photoinduced electrons and holes from the interlayer excitons move against the applied electric field toward the electrodes, limiting their contribution to the positive photocurrent. Consequently, the only mechanism responsible for the photoresponse of our photodetector under 980 and 1550 nm wavelength light is the generation and extraction of interlayer excitons, as no photoresponse was observed at $V_{DS} = 5$ V. In contrast, because our photodetector exhibits photodetection under 850 nm light even at $V_{DS} = 5$ V, a portion of the photocurrent arises from the excited photoinduced electrons in HfS₂. When HfS₂/MoS₂ detects light that each MoS₂ and HfS₂ cannot detect, the presence or absence of asymmetric photocurrent caused by bias polarity provides evidence that photocarriers resulting from interlayer excitation contribute to the photocurrent.^[17] In particular, given the low likelihood of additional defects forming in the HfS₂/MoS₂ structure or Hf doping occurring in MoS₂, the sole source for photocarrier generation is interlayer excitation. Consequently, we have demonstrated a high-performance IR detector utilizing photocarriers generated through interlayer excitons in the CVD-synthesized HfS₂/MoS₂ structure.

3. Conclusion

In summary, we successfully demonstrated high-performance photodetectors based on a CVD-grown HfS₂/MoS₂ heterojunction. In our two-step CVD process, HfS₂ exhibited exclusive growth only on MoS₂, resulting in the establishment of a vertical heterojunction with a substantial interface area. This favorable configuration effectively promotes the generation of interlayer excitons. The interface between HfS₂ and MoS₂ exhibits an energy barrier, resulting in a low dark current, and the low interlayer bandgap enables the detection of IR signals by interlayer excitons. Through comprehensive chemical analyses, we confirmed the synthesis of high-quality epitaxial HfS₂/MoS₂ heterojunctions without defects or interface contamination using a two-step CVD method. The HfS₂/MoS₂ photodetector exhibited a remarkable performance, with a D^* of $\approx 5 \times 10^{14}$ Jones at a wavelength of 470 nm, representing a 36-fold improvement over the MoS₂ photodetector. Notably, at a wavelength of 1550 nm, which is beyond the detection range of the individual HfS₂ and MoS₂ channels, the HfS₂/MoS₂ photodetector achieved an R of ≈ 600 A W⁻¹, D^* of $\approx 7 \times 10^{13}$ Jones, and rapid rise and decay times of 60 and 71 μ s, respectively. This interlayer exciton-driven IR sensor, which was first reported as a TMDC synthesized by CVD, opens up possibilities for the large-scale development of high-performance 2D IR sensors.

4. Experimental Section

Growth of MoS₂: CVD growth of MoS₂ was performed using a 2-inch tubular furnace. The process began with the preparation of a sam-

ple through the predeposition of MoO₃ and NaCl on a substrate, which was then placed in a crucible. The crucible was positioned at the center of the main heater. A crucible containing 4 g sulfur powder was placed upstream of the sample. The distance between the sulfur-filled crucible and the sample was set to 20 cm. Ar was used as the carrier gas, and the flux was maintained at 200 sccm throughout the experiment. The chamber was heated at a rate of 30 °C min⁻¹ with a pressure maintained at 760 Torr by controlling the valve of the exhaust line. Once the temperature reached 150 °C, it was maintained for 15 min. Subsequently, the heating rate was reduced to 25 °C min⁻¹ until a temperature of 500 °C was achieved. At this point, the heating zone of sulfur vaporized. Consequently, when the chamber temperature reached 750 °C, the temperature of the sulfur had increased by 200 °C. The main heater and heating zone of the sulfur were turned off after the temperature was maintained at 750 °C for 20 min. The system was then allowed to cool naturally.

Growth of HfS₂/MoS₂ Vertical Heterojunction: The growth of the vertical heterojunction was performed using a 1-inch tubular furnace. MoS₂ on SiO₂ was placed in a crucible at the center of the main heater. A mixture of HfCl₄ (0.02 g) and NaCl (0.01 g) was placed inside the crucible on the side farther from MoS₂. Upstream of the crucible, 4 g of sulfur was placed 15 cm from MoS₂. Throughout the process, a flow of H₂ gas (15 sccm) and Ar (20 sccm) gases were used. MoS₂ was heated at a rate of 30 °C min⁻¹ until it reached 150 °C, which was then maintained for 15 min. The temperature was subsequently increased at a higher rate of 40 °C min⁻¹ up to 500 °C. At this point, the sulfur heating zone was turned on. When the temperature of the main heater reached 950 °C, the sulfur heating zone reached 150 °C. These conditions were maintained for 30 min. The system was allowed to cool naturally, and the HfS₂/MoS₂ vertical heterojunction growth process was completed.

Characterization: Optical microscopy (BX53M, Olympus), Raman spectroscopy (InVia, Renishaw, 514 nm laser), PL measurement (UNINANOTECH, $\lambda_{\text{ext}} = 532$ nm), time-resolved PL (467 nm pulsed laser, Fluorolog 3, Horiba Scientific; time-correlated single-photon spectrometer), XPS (K-alpha, Thermo Fisher Scientific; Al K α source at 1486.6 eV; pass energy: 50 eV), and AFM (Innova, Bruker) were used for pristine MoS₂ and HfS₂/MoS₂ heterojunction characterization. For the TEM measurements, the HfS₂/MoS₂ heterojunction was transferred to a TEM grid (lacey carbon on an Au mesh) using a polystyrene-assisted transfer method. High-resolution TEM imaging was performed using a Cs-corrected TEM (HD-2300A, Hitachi). For the electrical/optoelectronic properties of MoS₂ and HfS₂/MoS₂, the source and drain electrodes were deposited by the thermal evaporation of Cr/Au (3/70 nm) and patterning with a shadow mask on MoS₂ and HfS₂/MoS₂. The electronic and optoelectronic properties of the devices were characterized using a semiconductor parameter analyzer (4200-SCS, Keithley) under vacuum (2 mTorr) using light-emitting diodes of various wavelengths ($\lambda = 470, 530, 625, 850, 980, \text{ and } 1550$ nm). The high-speed photoresponse was measured using an oscilloscope and a current amplifier under 532 and 1064 nm wavelength laser, and the on- and off-states of the laser were modulated using a mechanical chopper.

Supporting Information

Supporting Information is available from the Wiley Online Library or from the author.

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Conflict of Interest

The authors declare no conflict of interest.

Data Availability Statement

The data that support the findings of this study are available in the supplementary material of this article.

Keywords

epitaxy growth, HfS₂/MoS₂, interlayer exciton, infrared sensors, vertical heterojunction

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